

VI TELEFILTER**Filter Specification****TFS 70 E - 1/3****Application**

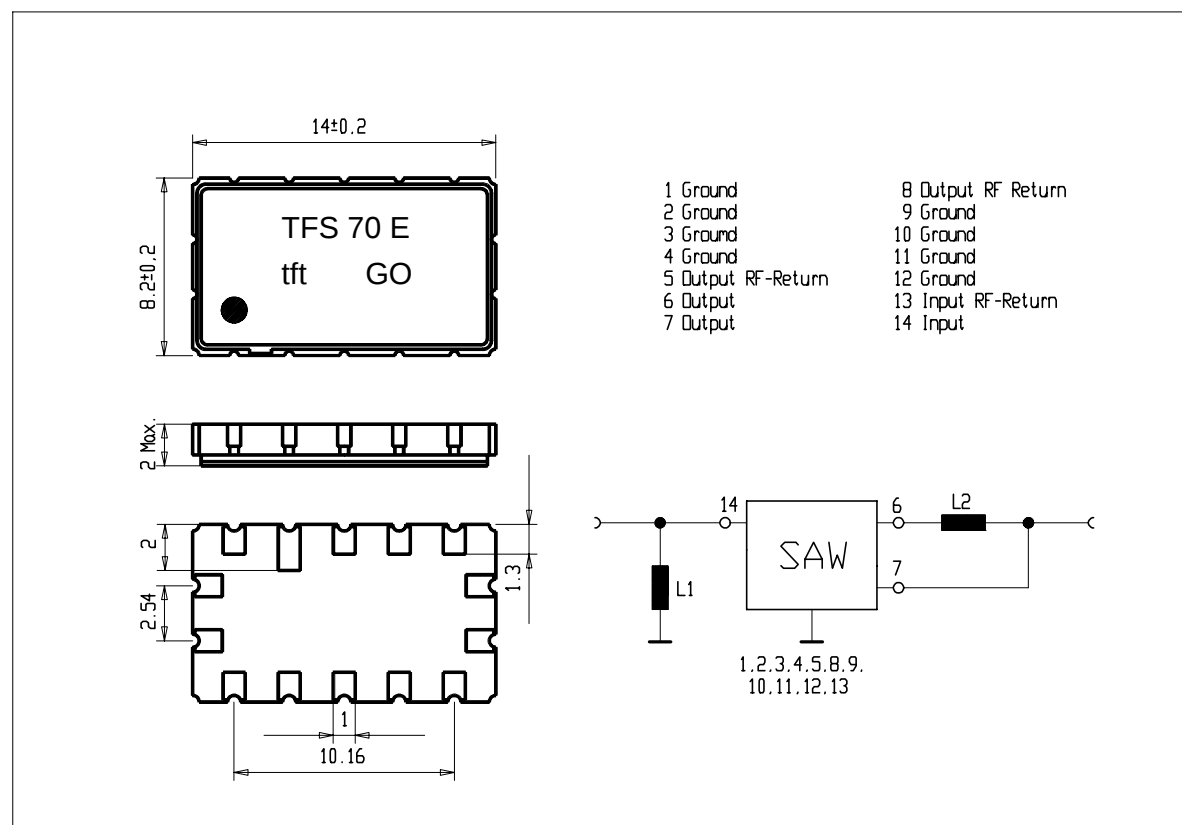
- Low insertion loss
- Radio communication
- Constant group delay
- SMD multilayer ceramic package, hermetically sealed

Characteristics

- Ambient temperature $T_A = 23\text{ }^{\circ}\text{C}$
- Input power level = 0 dBm
- Source impedance = 50 Ω matching network
- Load impedance = 50 Ω matching network

Description

		typ. value	Variation / Limitation
Insertion loss (Reference level)	a_e	5 dB	max 7 dB
Centre frequency	f_0	70,2 MHz	-
3 dB - band width		900 kHz	min 700 kHz
Relative attenuation	a_{rel}		
$f_0 \pm 350\text{ kHz}$		2 dB	max 3 dB
$f_0 + 1,15\text{ MHz} \dots f_0 + 1,65\text{ MHz}$		26 dB	min 20 dB
$f_0 - 1,2\text{ MHz} \dots f_0 - 1,65\text{ MHz}$		26 dB	min 20 dB
$f_0 + 1,65\text{ MHz} \dots f_0 + 2\text{ MHz}$		38 dB	min 35 dB
$f_0 - 1,65\text{ MHz} \dots f_0 - 3\text{ MHz}$		38 dB	min 35 dB
Group delay	GD	1,35 μs	-
Group delay ripple	$f_0 \pm 350\text{ kHz}$	$\pm 125\text{ ns}$	max $\pm 175\text{ ns}$
Temperature coefficient TC 1st order		- 72 ppm/K	-
DC - voltage	V_{dc}	-	max 12 V
AC - voltage	V_{ac}	-	max 10 V

Package, pin connection and 50 Ω matching network**Generated:****Checked / approved:****VI TELEFILTER****Potsdamer Straße 18****D 14 513 TELTOW / Germany****Tel: (+49) 3328 4784-52 / Fax: (+49) 3328 4784-30****E-Mail: tft@telefilter.com****Vectron International****267 Lowell Road****Hudson, NH 03051 / USA****Tel: (603) 598-0070 Fax: (603) 598-0075****E-Mail: vti@vtinh.com**

VI TELEFILTER**Filter Specification****TFS 70 E - 2/3****Stability Characteristics**

After the following tests the filter shall meet the whole specification:

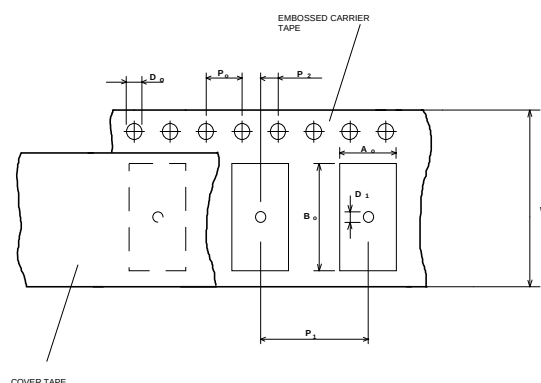
1. Shock: 100g, 18 ms, half sine wave, 3 shocks each plane;
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0,075 mm or 1g respectively, 1 octave per min, 10 cycles per plan, 3 plans;
DIN IEC 68 T2 - 6
3. Damp heat:
(steady state) 90 % to 95 % rel. humidity, 40 °C, 10 days;
DIN IEC 68 - 2 - 3
4. Resistance to
solder heat (reflow): max. 2 times reflow process;
for temperature conditions refer to the attached "Air reflow temperature conditions" on sheet 4;

Packing

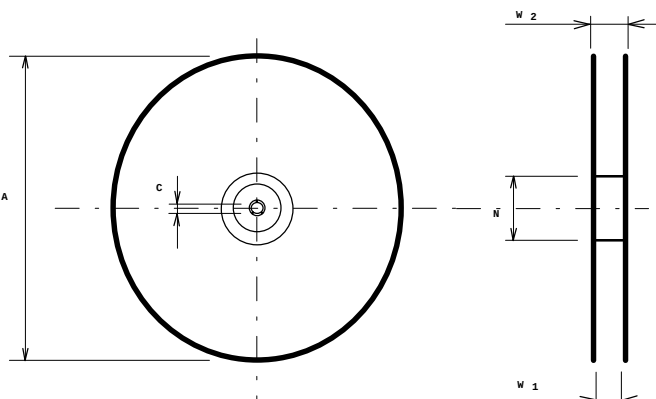
Tape & Reel: IEC 286 - 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

Tape (all dimensions in mm)

W	:	24	± 0,3
Po	:	4	± 0,1
P1	:	12	± 0,1
P2	:	2	± 0,05
Do	:	1,5	+ 0,5
D1	:	1,5	+ 0,5
Ao	:	8,8	± 0,1
Bo	:	14,6	± 0,1

**Reel (all dimensions in mm):**

A	:	330
W1	:	16,4 +2
W2 (max)	:	22,4
N (min)	:	>= 90
C	:	13 ± 0,25



The minimum bending radius is 45 mm. The mounting surface of the filters faces the bottom side of the embossed carrier tape. The marking of the filters is able to read if the view is directed on the upper side of the carrier tape with the sprocket holes on the right side of the tape.

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Air reflow temperature conditions

1st and 2nd air reflow profile

Name:	pre-heating periods	main-heating periods	peak temperature
Temperature:	150 °C - 170 °C	over 200 °C	255 °C ± 5 °C
Time:	60 sec. - 90 sec.	20 sec. - 25 sec.	

Chip-mount air reflow profile

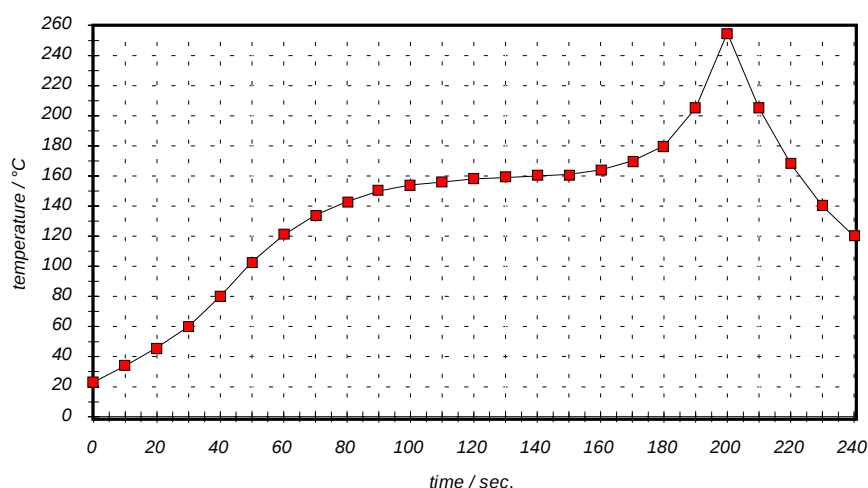


Table for temperature vs. time during the air reflow process

Tolerance of temperatures: ± 5 °C

time / sec.	temperature / °C	time / sec.	temperature / °C
0	23	140	160
10	34	150	161
20	46	160	164
30	60	170	170
40	80	180	180
50	103	190	205
60	121	195	230
70	134	200	255
80	143	205	230
90	150	210	205
100	154	215	180
110	156	220	165
120	158	230	140
130	159	240	120

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